

REV.	SPECIFICATION	ECN NO.	APPD.
R1		ECN220555	

**Material and Plating:**

Housing: LCP, UL94V-0, BLACK.

Contacts : Brass .

Gold Plated or Tin Plated and 80μ" min Tin on Solder Tail over Nickel 50u" Min .

**Electrical Characteristics:**

Current Rating: 2 AMP.

Dielectric Withstanding Voltage: AC 1000V for 1 minute.

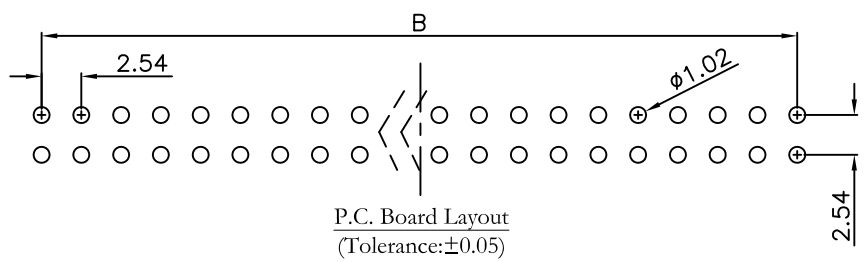
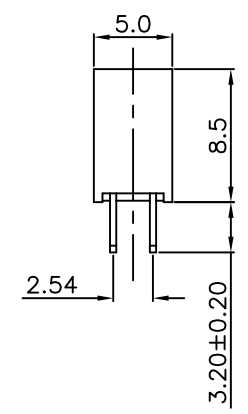
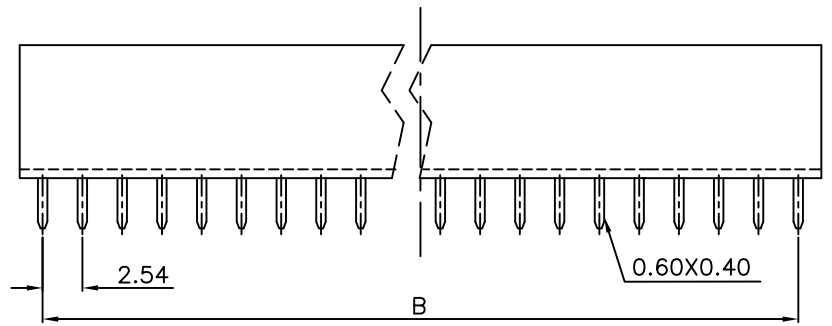
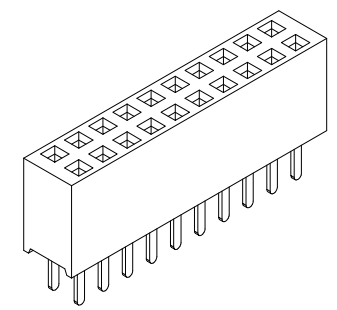
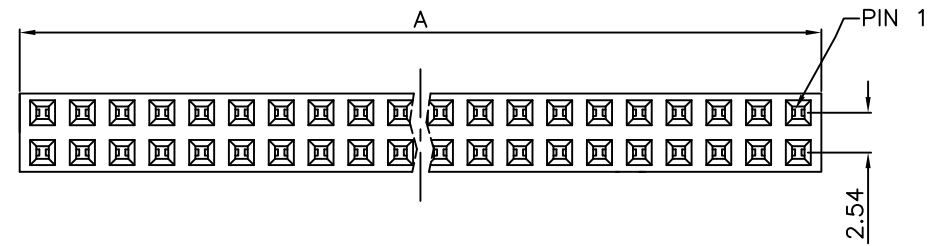
Insulator Resistance: 1000MΩ min. at DC 500V.

Contact Resistance: 20mΩ max. at DC 100mA.

Operating Temperature: -55°C~+105°C .

**\*RoHS Compliant**

Insertion Depth: 2.55mm to 6.20mm.



Series: 2044- 2 X xx G xx S A -LCP  
 Double Row: 2 X xx  
 No. of Pin Per Row: xx  
 G: Gold Plated  
 T: Tin Plated  
 S: Straight  
 A: Tray Package  
 B: Bulk Package  
 LCP: Housing Material LCP  
 00: G/F  
 10: 10μ"  
 15: 15μ"  
 30: 30μ"

Position Dimension	4 Thru 80
A	2.54 X No. of Position /2+0.4
B	2.54 X No. of Position /2-2.54

Tolerances	Dwg. No.	2044-D0000-031	Title:
x = ±0.5	Projection		2044 Series
.x = ±0.25	Unit	mm	P.C.B. Socket
.xx = ±0.15	Scale	1:1	2.54mmX2.54mm(0.100"X0.100")
	Drawn By	ZY 05/29'22	

<b>OUPIN</b>			
OUPIN ELECTRONIC(KUNSHAN) CO., LTD.			
P/N: 2044-2XxxGxxSA-LCP			
SHEET	1/1	Ver. No.	R1